

View Online at https://aerobasegroup.com/nsn/5910-01-276-2246

Body Style:	
Chip type	
Reliability Indicator:	
Established	
Reliability Failure Rate Level In Percent:	
0.010	
Terminal Length:	
Between 0.005 inches and 0.025 inches	
Body Length:	
Between 0.090 inches and 0.145 inches	
Body Width:	
Between 0.090 inches and 0.130 inches	
Body Height:	
Between 0.030 inches and 0.102 inches	
Schematic Diagram Designator:	
No common or grounded electrode (s)	
Insulation Resistance At Maximum Operating Temp:	
100000.0 megohms	
Capacitance Value Per Section:	
1.000 picofarads single section	
Nonderated Operating Temp:	
Between -55.0 degrees celsius and 125.0 degrees celsius	
Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:	
90.0 single section	
Nonderated Continuous Voltage Rating And Type Per Section:	
500.0 dc single section	
Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:	
-20.0/+20.0 single section	
Tolerance Range Per Section:	
-0.10/+0.10 picofarads single section	
Case Material:	
Ceramic or glass	
Insulation Resistance At Reference Temp:	
100000.0 megohms	
Dissipation Factor At Reference Tempurature In Percent:	
0.050	
Quality Factor At Reference Temp:	
100000.000	
Terminal Surface Treatment:	
Solder	
Test Data Document:	
81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification	
format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain	

environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).



## Terminal Type And Quantity:

2 bonding pad

## Specification Data:

81349-mil-c-55681/4 government specification

Shelf Life:

N/a

## Unit Of Measure:

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## Demilitarization:

No

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